

# UNISONIC TECHNOLOGIES CO., LTD

UTT15P10

**Preliminary** 

**Power MOSFET** 

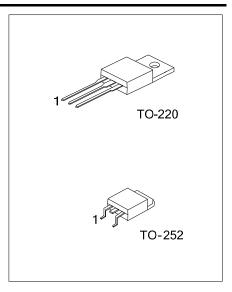
# -15A, -100V P-CHANNEL POWER MOSFET

#### **■** DESCRIPTION

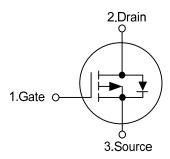
The UTC **UTT15P10** is a P-channel power MOSFET using UTC's advanced technology to provide the customers with high switching speed, cost-effectiveness and minimum on-state resistance. It can also withstand high energy in the avalanche.

#### **■ FEATURES**

- \*  $R_{DS(ON)}$  < 260 m $\Omega$  @  $V_{GS}$  = -10V,  $I_D$  = -7.5A  $R_{DS(ON)}$  < 400 m $\Omega$  @  $V_{GS}$  = -4.5V,  $I_D$  = -7.5A
- \* High Switching Speed



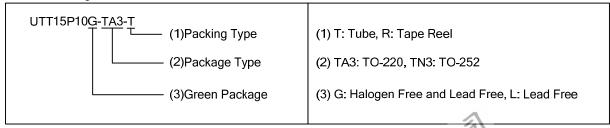
#### ■ SYMBOL



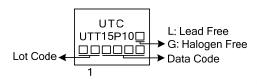
#### **■ ORDERING INFORMATION**

| Ordering Number |                 | Dookogo | Pin Assignment |   |   | Dooking   |  |
|-----------------|-----------------|---------|----------------|---|---|-----------|--|
| Lead Free       | Halogen Free    | Package | 1              | 2 | 3 | Packing   |  |
| UTT15P10L-TA3-T | UTT15P10G-TA3-T | TO-220  | G              | D | S | Tube      |  |
| UTT15P10L-TN3-R | UTT15P10G-TN3-R | TO-252  | G              | D | S | Tape Reel |  |

Note: Pin Assignment: G: Gate D: Drain S: Source



## ■ MARKING



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# ■ ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub>=25°C, unless otherwise specified)

| PARAMETER                 |               | SYMBOL           | RATINGS    | UNIT |  |
|---------------------------|---------------|------------------|------------|------|--|
| Drain-Source Voltage      |               | $V_{DSS}$        | -100       | V    |  |
| Gate-Source Voltage       |               | $V_{GSS}$        | ±25        | V    |  |
| Drain Current             | Continuous    | I <sub>D</sub>   | -15        | Α    |  |
|                           | Pulsed        | I <sub>DM</sub>  | -60        | Α    |  |
| Avalanche Energy (Note 3) | Single Pulsed | E <sub>AS</sub>  | 45         | mJ   |  |
| Power Dissipation         | TO-220        | ם                | 90         | W    |  |
|                           | TO-252        | $P_{D}$          | 60         |      |  |
| Junction Temperature      |               | Τ <sub>J</sub>   | +150       | °C   |  |
| Storage Temperature       |               | T <sub>STG</sub> | -55 ~ +150 | °C   |  |

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating : Pulse width limited by maximum junction temperature.
- 3. L=0.4mH,  $I_{AS}$ =-15A,  $V_{DD}$ =-50V,  $R_{G}$ =25  $\Omega$ , Starting  $T_{J}$  = 25°C
- 4.  $I_{SD} \le -15A$ , di/dt $\le 200A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25^{\circ}C$

#### **■ THERMAL DATA**

| PARAMETER           |        | SYMBOL          | RATINGS | UNIT |  |
|---------------------|--------|-----------------|---------|------|--|
| Junction to Ambient | TO-220 | 0               | 62.5    | °C/W |  |
|                     | TO-252 | θ <sub>JA</sub> | 110     | °C/W |  |
| Junction to Case    | TO-220 | 0               | 1.38    | °C/W |  |
|                     | TO-252 | θЈС             | 2.08    |      |  |



# ■ **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub>=25°C, unless otherwise specified)

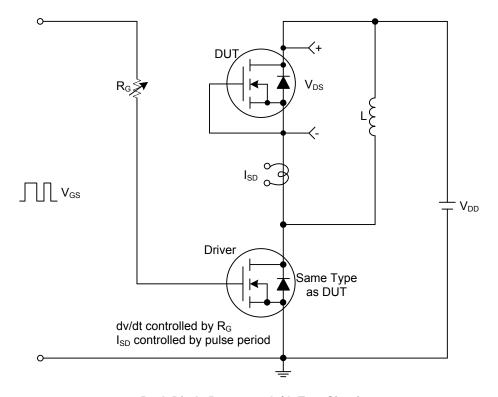
| PARAMETER                                   | SYMBOL                      | TEST CONDITIONS N                                    |      | TYP  | MAX  | UNIT |
|---|-----------------------------|--|------|------|------|------|
| OFF CHARACTERISTICS                         |                             |  |      |      |      |      |
| Drain-Source Breakdown Voltage              | BV <sub>DSS</sub>           | $I_D$ =-250 $\mu$ A, $V_{GS}$ =0 $V$                 | -100 |      |      | ٧    |
| Drain-Source Leakage Current                | I <sub>DSS</sub>            | V <sub>DS</sub> =-100V, V <sub>GS</sub> =0V          |      |      | -1   | μΑ   |
| Cata Source Leakage Current Forward         | I <sub>GSS</sub>            | $V_{GS}$ =+25V, $V_{DS}$ =0V                         |      |      | +100 | nΑ   |
| Gate-Source Leakage Current Reverse         |                             | $V_{GS}$ =-25V, $V_{DS}$ =0V                         |      |      | -100 | nA   |
| ON CHARACTERISTICS                          |                             |  |      |      |      |      |
| Gate Threshold Voltage                      | $V_{GS(TH)}$                | $V_{DS}=V_{GS}$ , $I_{D}=-250\mu A$                  | -1.0 |      | -3.0 | V    |
| Static Drain-Source On-State Resistance     | D                           | V <sub>GS</sub> = -10V, I <sub>D</sub> = -7.5A       |      |      | 260  | mΩ   |
| Static Drain-Source On-State Resistance     | R <sub>DS(ON)</sub>         | V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -7.5A      |      |      | 400  | mΩ   |
| DYNAMIC PARAMETERS (Note 2)                 |                             |  |      |      |      |      |
| Input Capacitance                           | C <sub>ISS</sub>            |  |      | 1200 |      | pF   |
| Output Capacitance                          | Coss                        | V <sub>GS</sub> =0V, V <sub>DS</sub> =-25V, f=1.0MHz |      | 64   |      | pF   |
| Reverse Transfer Capacitance                | C <sub>RSS</sub>            |  |      | 56   |      | pF   |
| SWITCHING PARAMETERS                        |                             | ,  |      | 1    |      |      |
| Total Gate Charge (Note 1)                  | $Q_G$                       | V <sub>DS</sub> =-50V, I <sub>D</sub> =-1.3A,        |      | 85   |      | nC   |
| Gate to Source Charge                       | $Q_GS$                      | V <sub>GS</sub> =-10V. I <sub>G</sub> =-1.00µA       |      | 4    |      | nC   |
| Gate to Drain Charge                        | $Q_GD$                      | ν (ςς - 10 ν, ιζ - 100μ/ ι                           |      | 8.8  |      | nC   |
| Turn-ON Delay Time (Note 1)                 | t <sub>D(ON)</sub>          |  |      | 10   |      | ns   |
| Rise Time                                   | t <sub>R</sub>              | V <sub>DD</sub> =-30V, I <sub>D</sub> =-0.5A,        |      | 46   |      | ns   |
| Turn-OFF Delay Time                         | t <sub>D(OFF)</sub>         | $R_G=25\Omega$ , $V_{GS}=0V$                         |      | 364  |      | ns   |
| Fall-Time                                   | $t_{\scriptscriptstyle{F}}$ |  |      | 180  |      | ns   |
| SOURCE- DRAIN DIODE RATINGS AND CH          | ARACTERIS                   | STICS  |      |      |      |      |
| Maximum Body-Diode Continuous Current       | Is                          |  |      |      | -15  | Α    |
| Maximum Body-Diode Pulsed Current           | I <sub>SM</sub>             |  |      |      | -60  | Α    |
| Drain-Source Diode Forward Voltage (Note 1) | $V_{SD}$                    | I <sub>F</sub> =-15A, V <sub>GS</sub> =0V            |      |      | -3.0 | V    |
| Body Diode Reverse Recovery Time (Note 1)   | t <sub>rr</sub>             | I <sub>S</sub> =-50A, V <sub>GS</sub> =0V,           |      | 280  |      | nS   |
| Body Diode Reverse Recovery Charge          | $Q_{rr}$                    | dI <sub>F</sub> /dt=100A/μs                          |      | 1385 |      | nC   |

Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤2%.

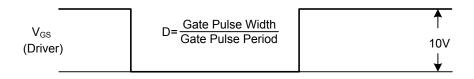


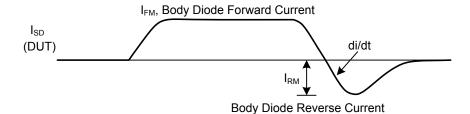
<sup>2.</sup> Essentially independent of operating temperature.

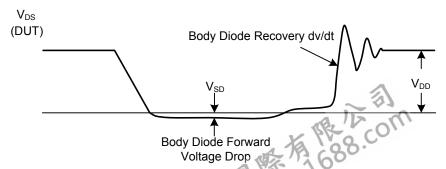
## ■ TEST CIRCUITS AND WAVEFORMS



#### Peak Diode Recovery dv/dt Test Circuit



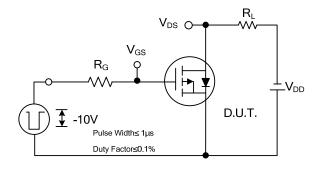


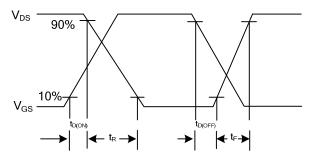


Peak Diode Recovery dv/dt Test Circuit and Waveforms

Peak Diode Recovery dv/dt Waveforms

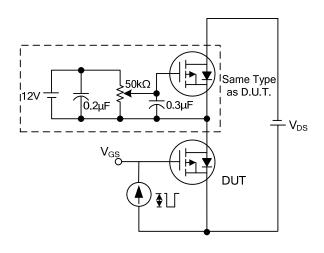
## **TEST CIRCUITS AND WAVEFORMS**

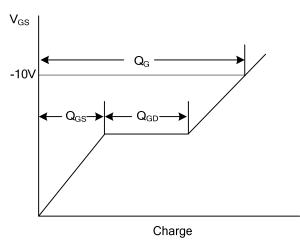




**Switching Test Circuit** 

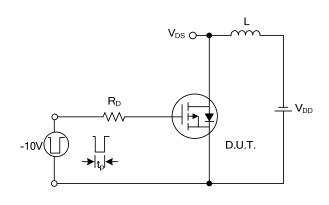
**Switching Waveforms** 

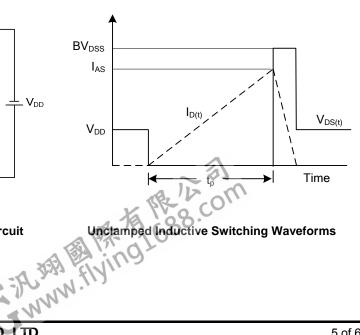




**Gate Charge Test Circuit** 

**Gate Charge Waveform** 





**Unclamped Inductive Switching Test Circuit** 

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**Power MOSFET**